

### FAST RECOVERY RECTIFIER

VOLTAGE RANGE: 50 --- 1000 V  
CURRENT: 2.0 A

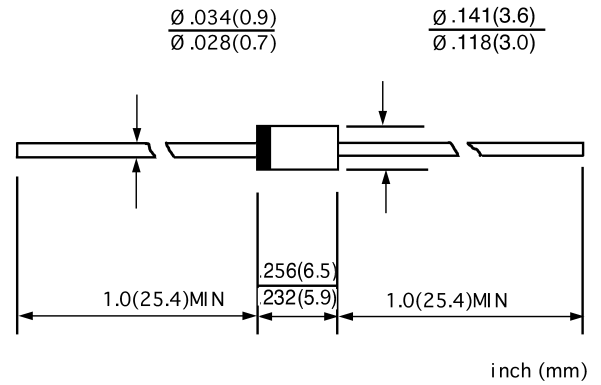
#### FEATURES

- ◇ Low cost
- ◇ Diffused junction
- ◇ Low leakage
- ◇ Low forward voltage drop
- ◇ High current capability
- ◇ Easily cleaned with Freon, Alcohol, Isopropanol and similar solvents
- ◇ The plastic material carries U/L recognition 94V-0

#### MECHANICAL DATA

- ◇ Case: JEDEC DO-15, molded plastic
- ◇ Terminals: Axial lead, solderable per MIL-STD-202, Method 208
- ◇ Polarity: Color band denotes cathode
- ◇ Weight: 0.014 ounces, 0.39 grams
- ◇ Mounting position: Any

#### DO - 15



#### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate by 20%.

		FR 201	FR 202	FR 203	FR 204	FR 205	FR 206	FR 207	UNITS
Maximum recurrent peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Maximum average forward rectified current 9.5mm lead length, @ $T_A=75^\circ\text{C}$	$I_{F(AV)}$	2.0							A
Peak forward surge current 8.3ms single half-sine-wave superimposed on rated load @ $T_J=125^\circ\text{C}$	$I_{FSM}$	70.0							A
Maximum instantaneous forward voltage @ 2.0 A	$V_F$	1.3							V
Maximum reverse current @ $T_A=25^\circ\text{C}$ at rated DC blocking voltage @ $T_A=100^\circ\text{C}$	$I_R$	5.0 100.0							$\mu\text{A}$
Maximum reverse recovery time (Note1)	$t_{rr}$	150			250		500		ns
Typical junction capacitance (Note2)	$C_J$	18							pF
Typical thermal resistance (Note3)	$R_{\theta JA}$	45							$^\circ\text{C/W}$
Operating junction temperature range	$T_J$	- 55---- +150							$^\circ\text{C}$
Storage temperature range	$T_{STG}$	- 55---- + 150							$^\circ\text{C}$

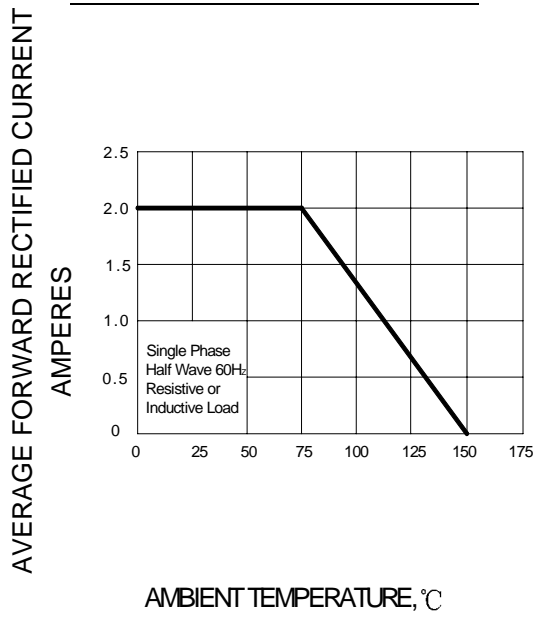
NOTE: 1. Measured with  $I_F=0.5\text{A}$ ,  $I_R=1\text{A}$ ,  $t_{rr}=0.25\text{A}$ .

2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

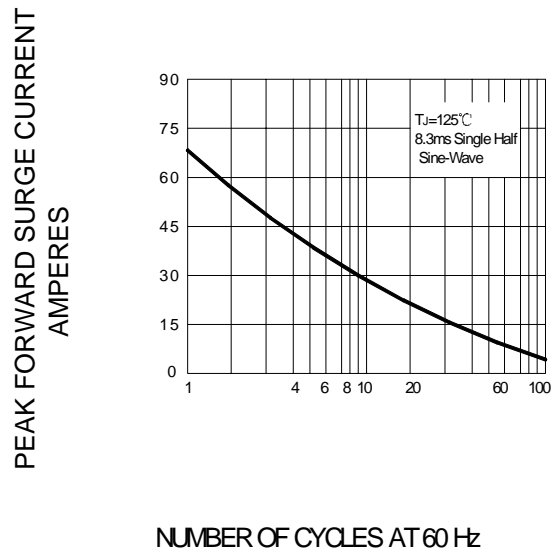
3. Thermal resistance from junction to ambient.

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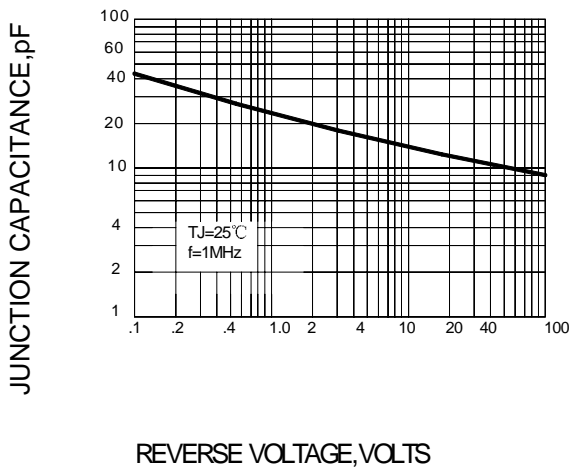
**FIG.1 – FORWARD DERATING CURVE**



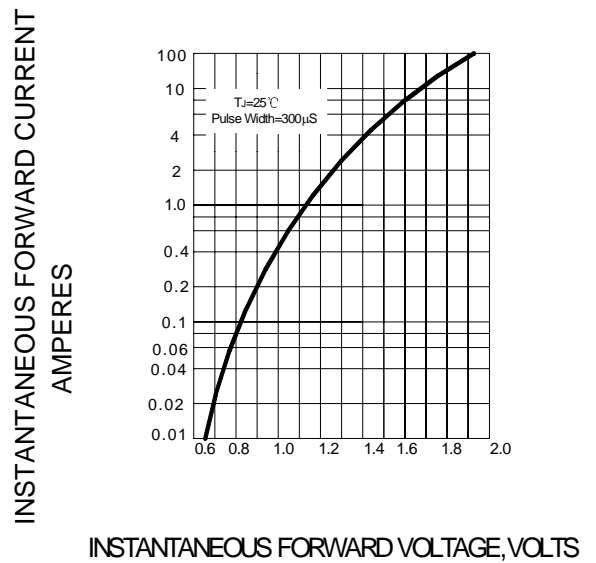
**FIG.2—PEAK FORWARD SURGE CURRENT**



**FIG.3—TYPICAL JUNCTION CAPACITANCE**



**FIG.4 –TYPICAL FORWARD CHARACTERISTIC**



**FIG.5 – REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM**

